

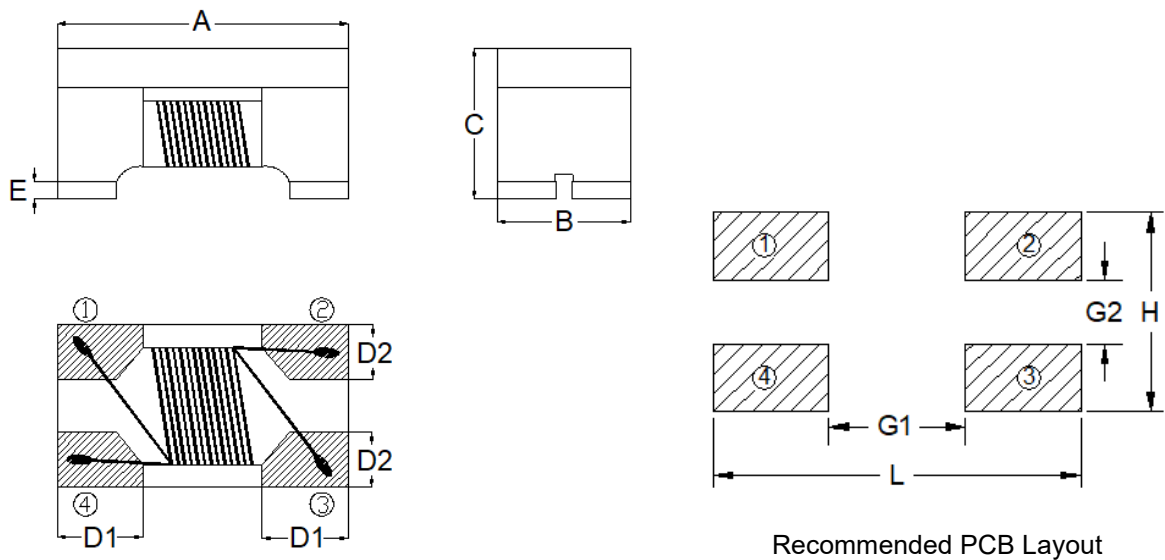
1. Part No. Expression

W 4 F 300 - R D - 10

(a) (b) (c) (d) (e) (f) (g)

- | | |
|--------------------|--------------------|
| (a) Series Code | (e) Packaging Code |
| (b) Dimension Code | (f) Current Code |
| (c) Material Code | (g) Internal Code |
| (d) Impedance Code | |

2. Configuration & Dimensions (Unit: mm)

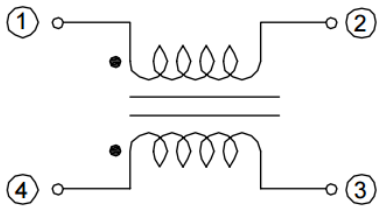


Note: The above PCB layout reference only.

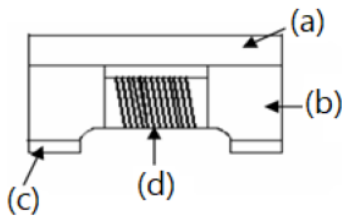
A	B	C	D1	D2
3.20±0.20	1.60±0.20	2.00±0.20	0.50±0.10	0.50±0.10
E	L	G1	G2	H
0.15±0.10	3.70 Ref	1.90 Ref	0.40 Ref	1.60 Ref

NOTE: Specifications subject to change without notice. Please check our website for latest information.

3. Schematic



4. Material List



- (a) Upper Plate
- (b) Core
- (c) Termination
- (d) Wire

5. General Specifications

- (a) Operating Temp.: -40°C to +125°C (including self-temperature rise)
- (b) Storage Temp.: -40°C to +125°C (On board)
- (c) Irms: Based on temperature rise ΔT 20°C Max at rated current < 1A and ΔT 40°C Max at rated current $\geq 1A$
- (d) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

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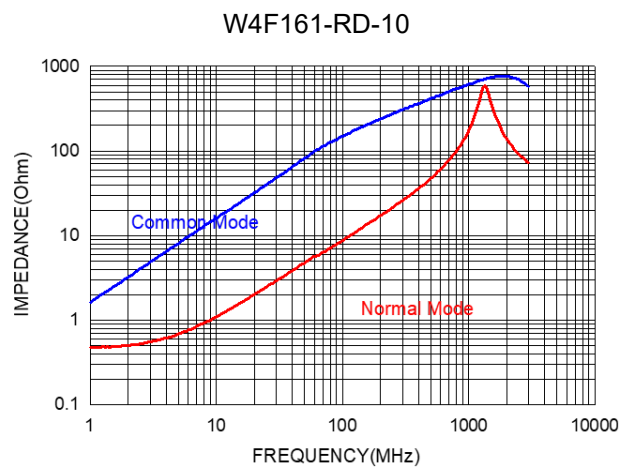
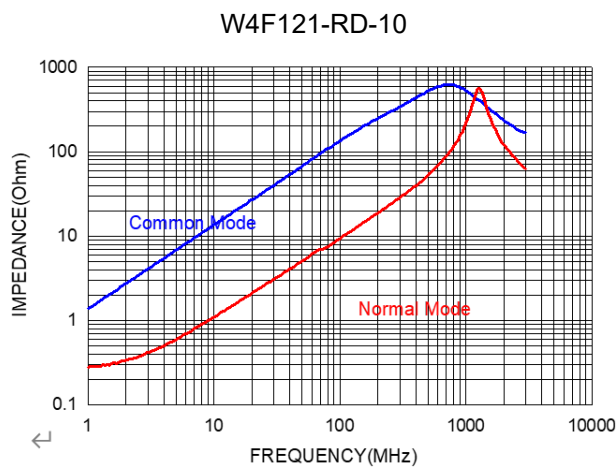
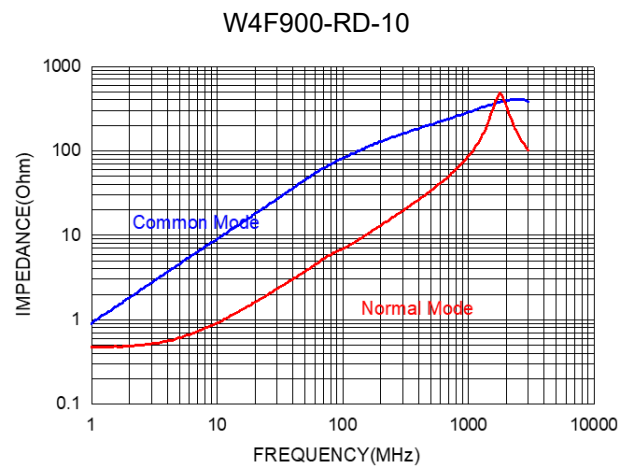
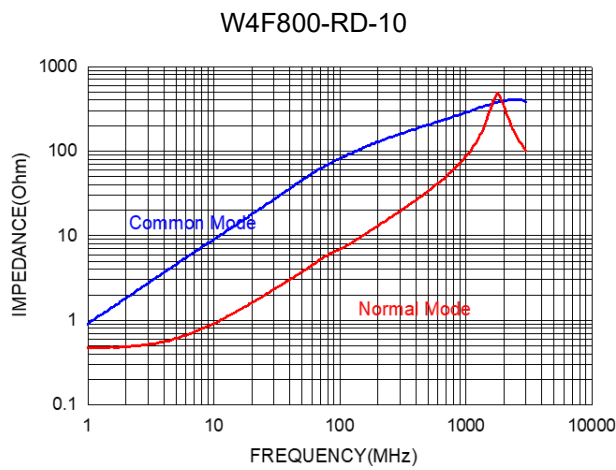
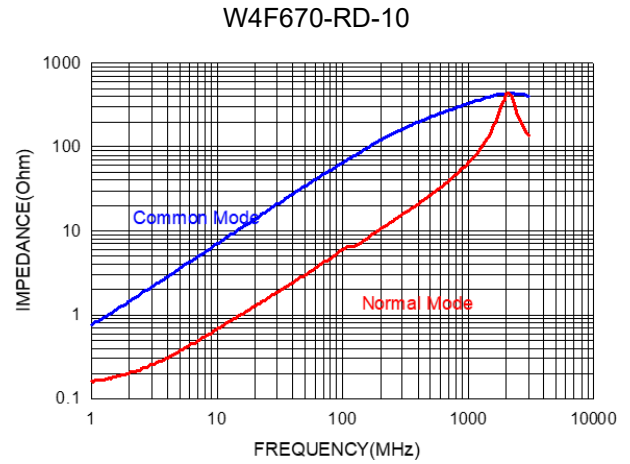
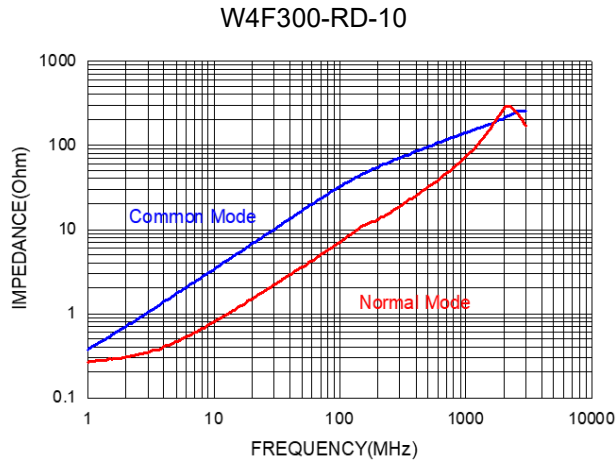
6. Electrical Characteristics

Part Number	Impedance (Ω) $\pm 25\%$	Test Frequency (MHz)	DCR (Ω) Max	Rated Current (mA) Max	Rated Voltage (Vdc) Max	Withstand Voltage (Vdc) Max	IR (M Ω) Min
W4F300-RD-10	30	100	0.20	400	50	125	10
W4F670-RD-10	67	100	0.30	400	50	125	10
W4F800-RD-10	80	100	0.30	400	50	125	10
W4F900-RD-10	90	100	0.30	400	50	125	10
W4F121-RD-10	120	100	0.30	350	50	125	10
W4F161-RD-10	160	100	0.40	350	50	125	10
W4F181-RD-10	180	100	0.40	340	50	125	10
W4F221-RC-10	220	100	0.45	300	50	125	10
W4F261-RC-10	260	100	0.50	300	50	125	10
W4F281-RC-10	280	100	0.50	300	50	125	10
W4F301-RC-10	300	100	0.60	300	50	125	10
W4F361-RC-10	360	100	0.60	300	50	125	10
W4F431-RC-10	430	100	0.80	300	50	125	10
W4F471-RC-10	470	100	0.80	300	50	125	10
W4F551-RC-10	550	100	0.80	300	50	125	10
W4F601-RC-10	600	100	0.80	300	50	125	10
W4F102-RB-10	1000	100	1.00	200	50	125	10
W4F222-RB-10	2200	100	1.20	200	50	125	10

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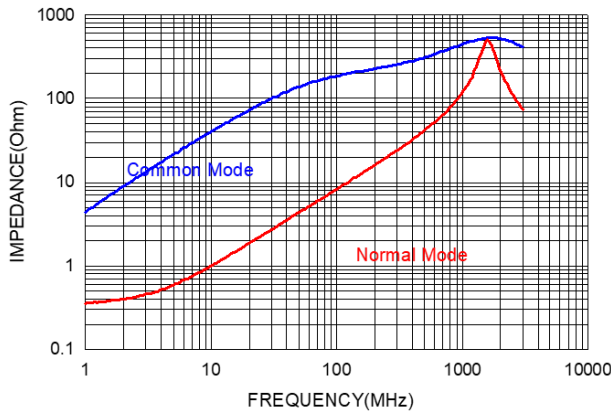
7. Characteristics Curve

7-1. Impedance versus Frequency

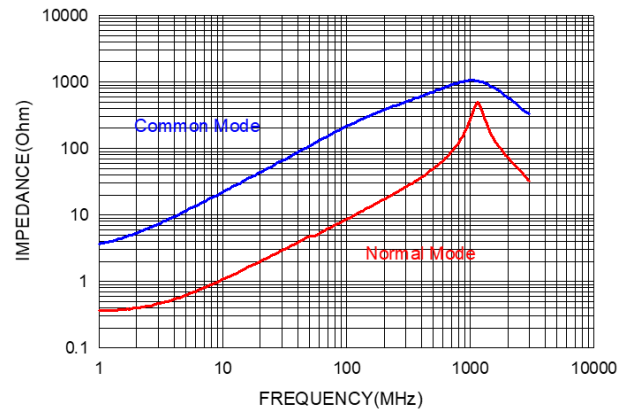


NOTE: Specifications subject to change without notice. Please check our website for latest information.

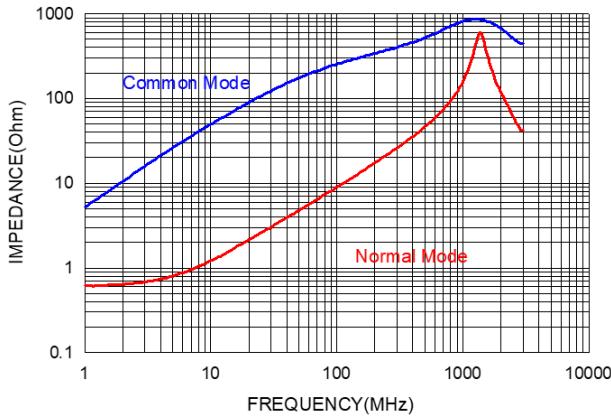
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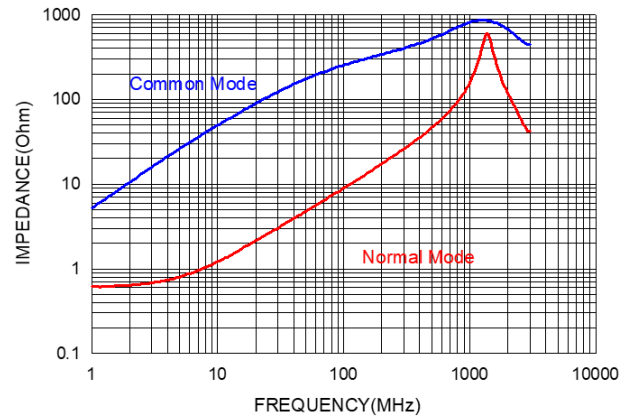
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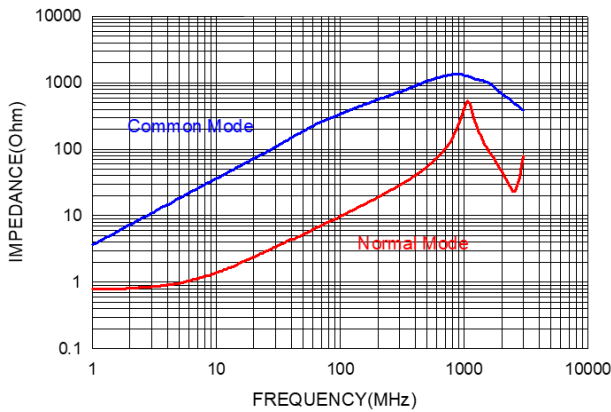
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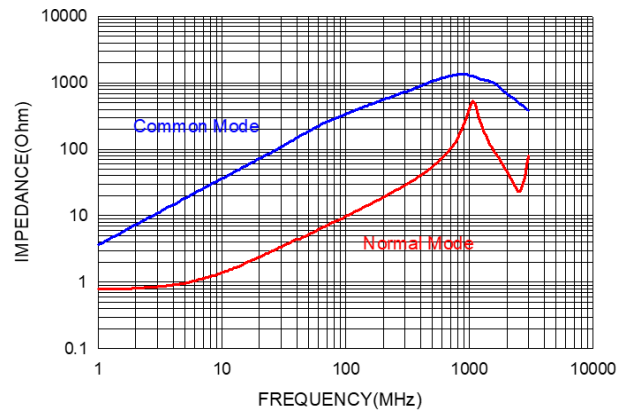
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W4F301-RC-10

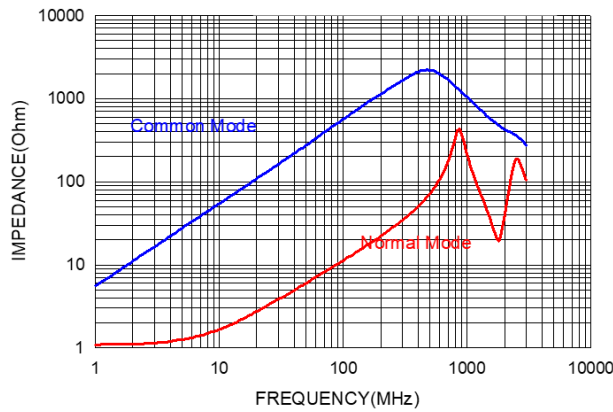


W4F361-RC-10

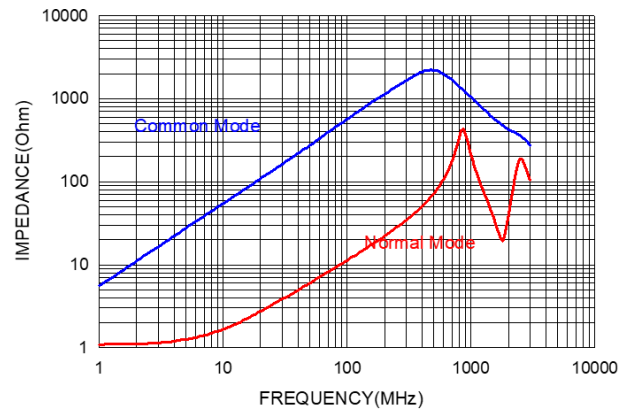


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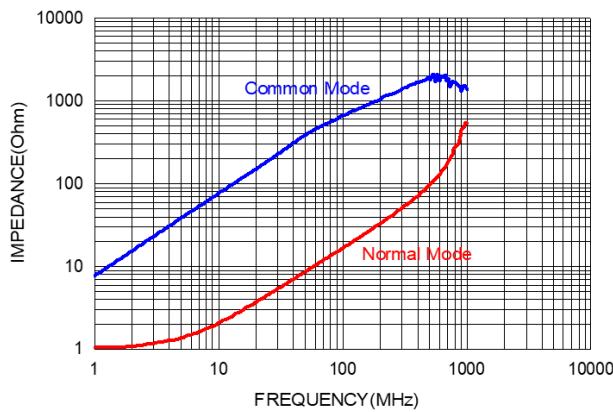
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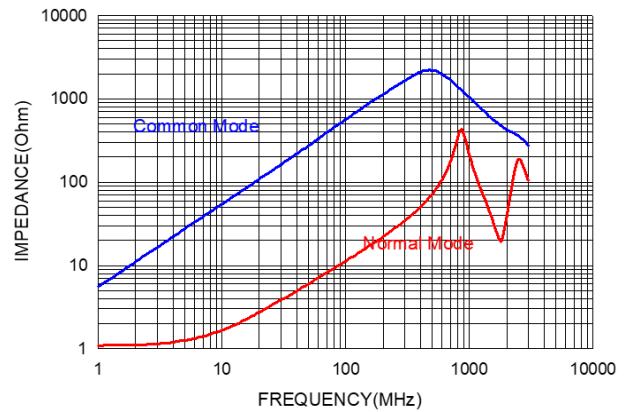
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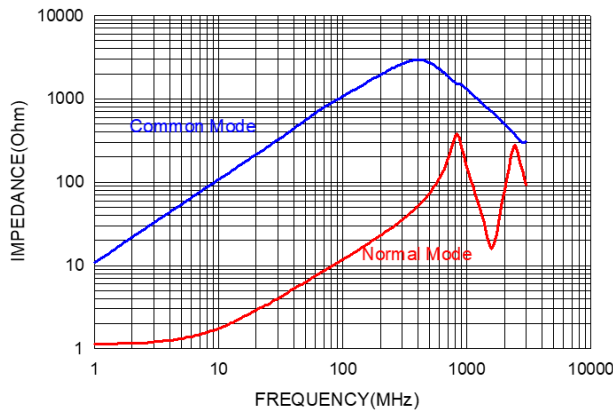
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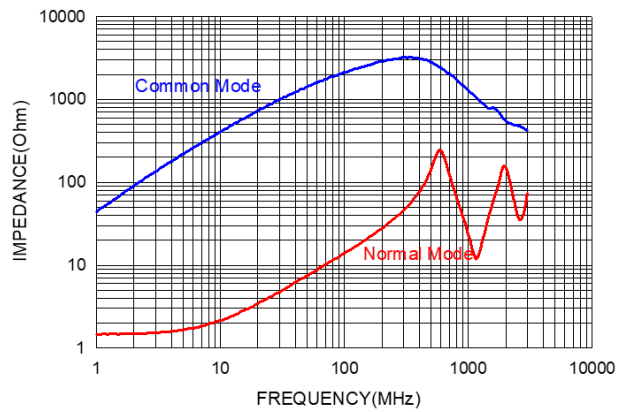
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W4F102-RB-10

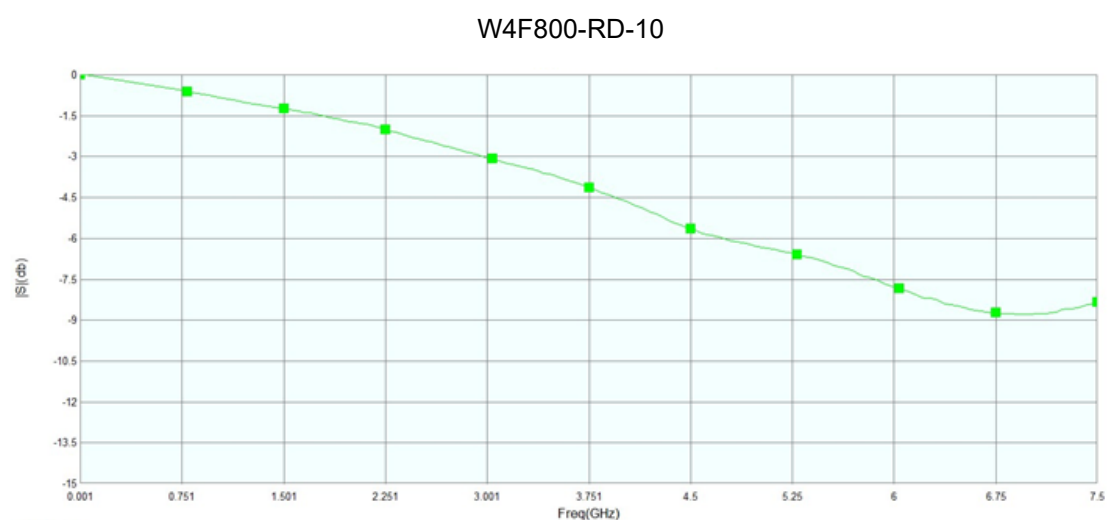
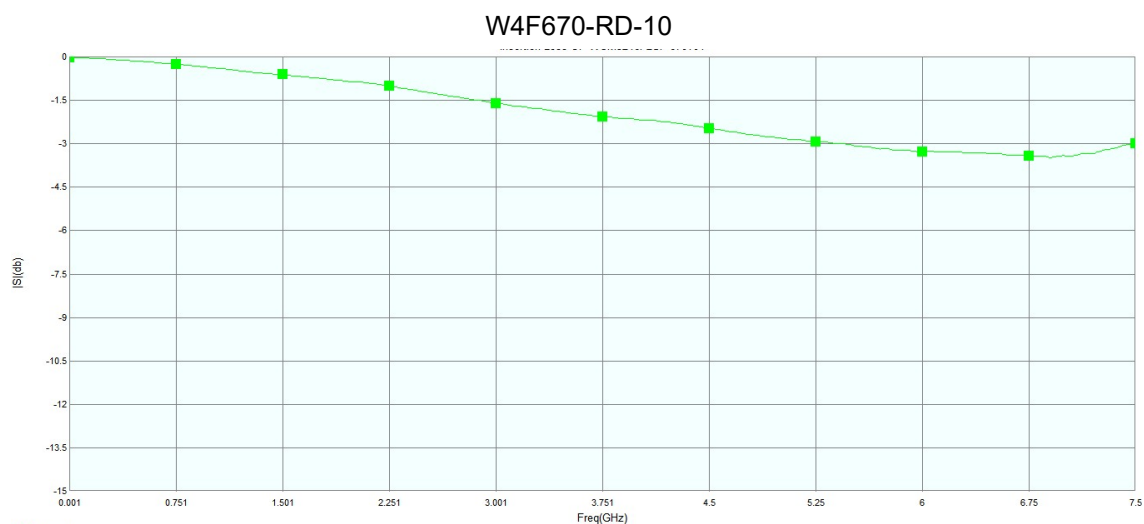
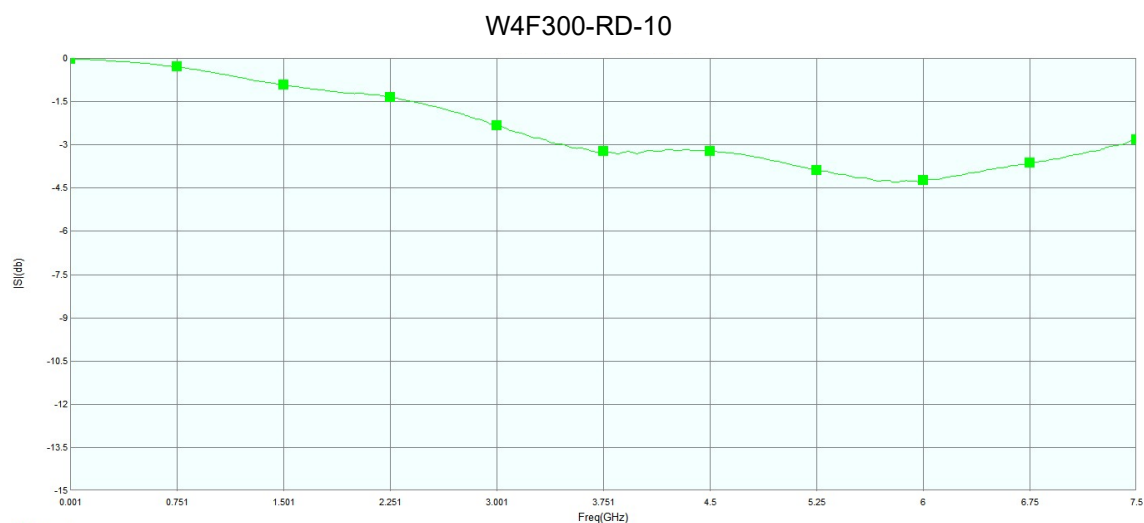


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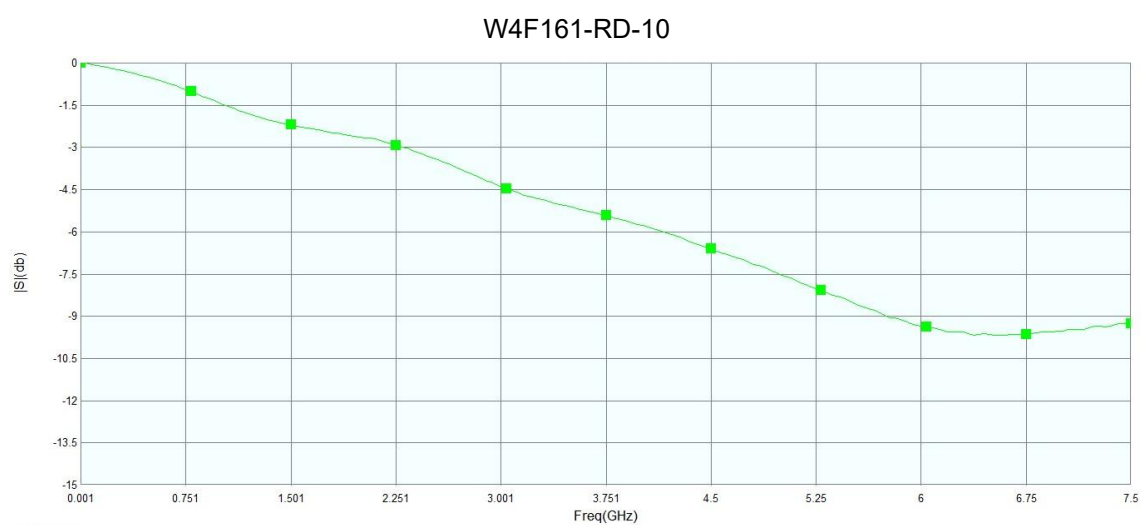
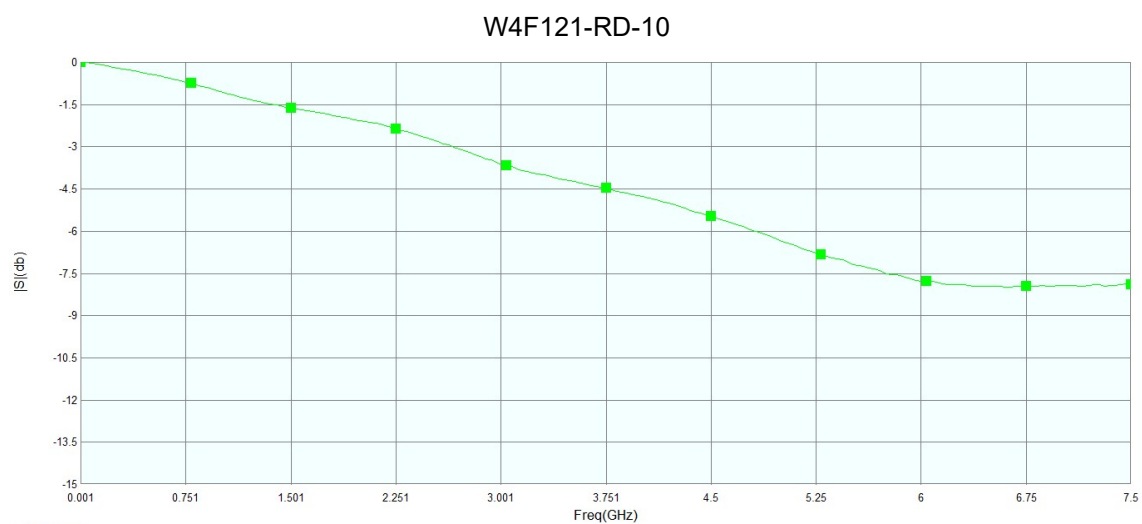
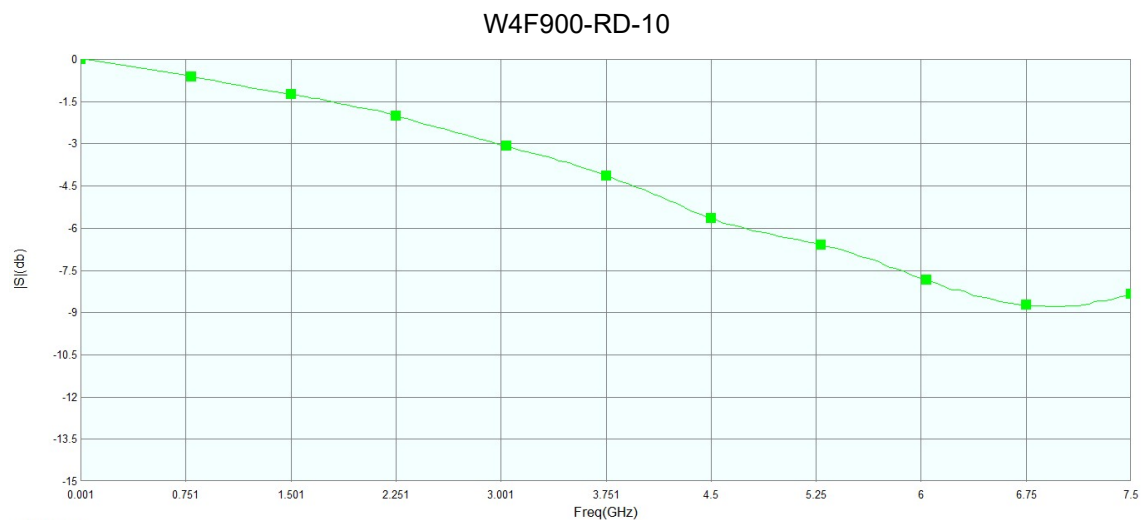


NOTE: Specifications subject to change without notice. Please check our website for latest information.

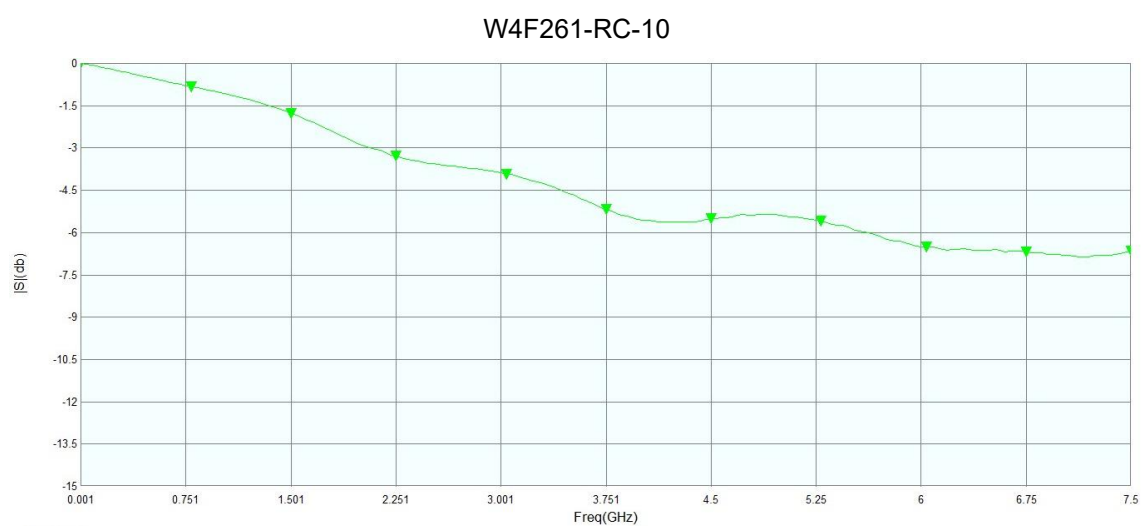
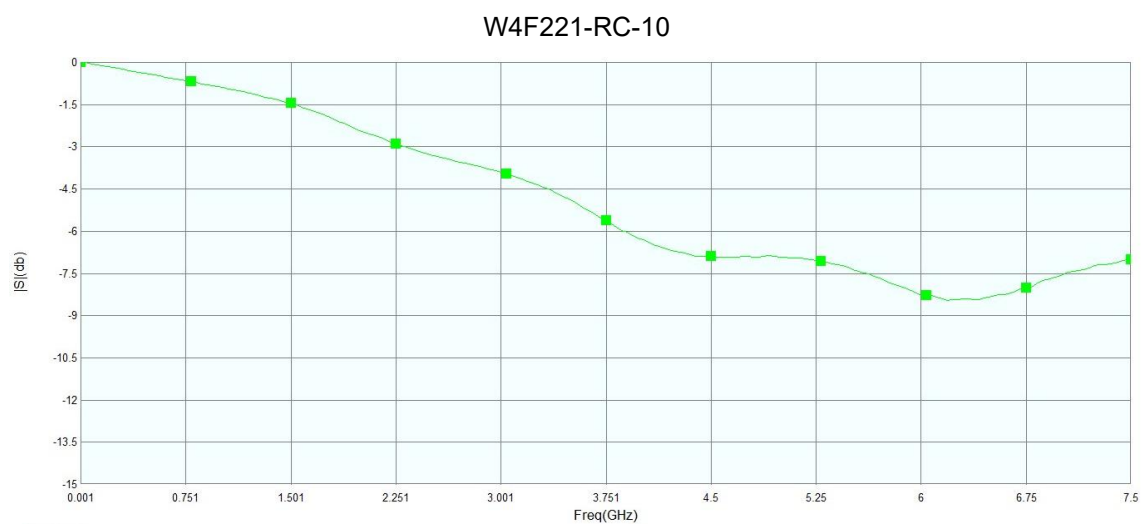
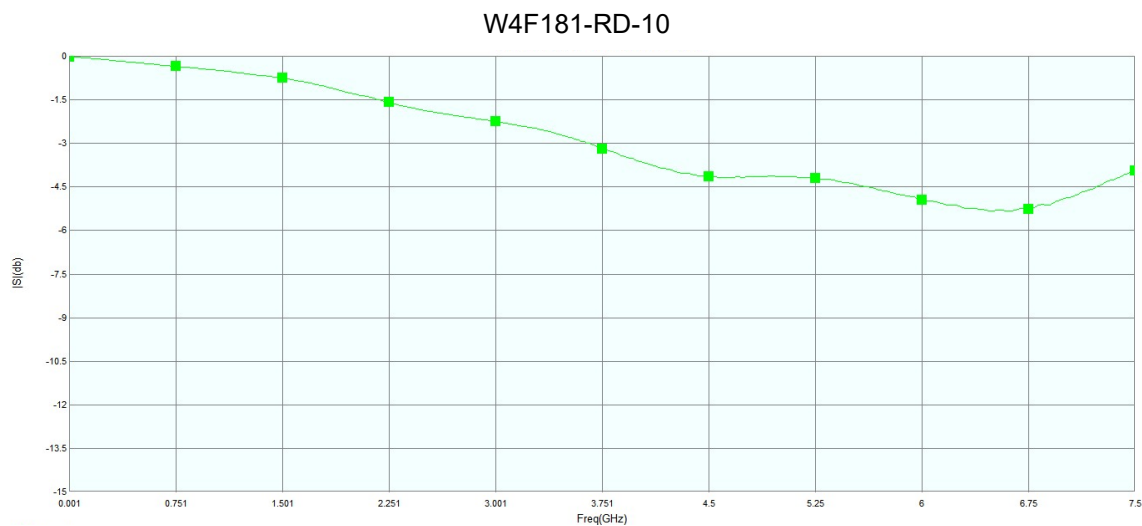
7-2. Insertion Loss Test



NOTE: Specifications subject to change without notice. Please check our website for latest information.

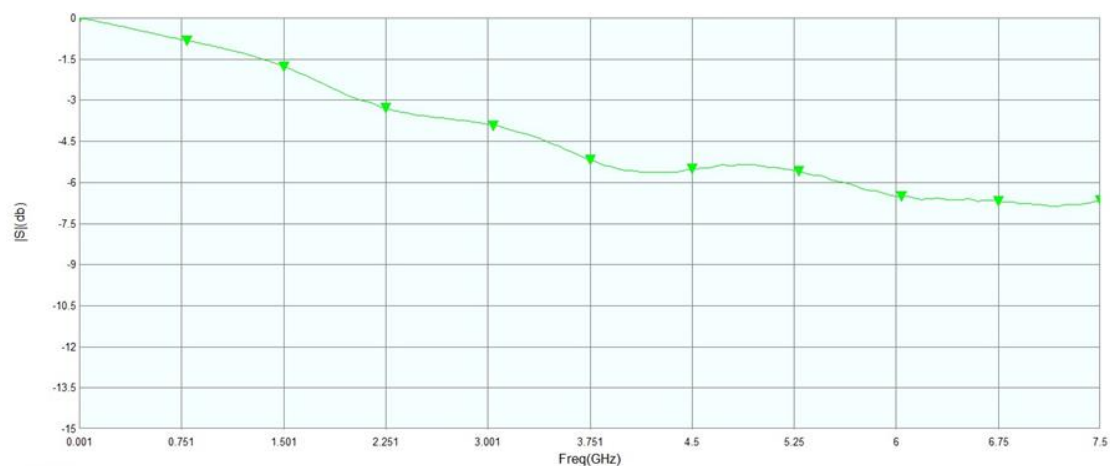


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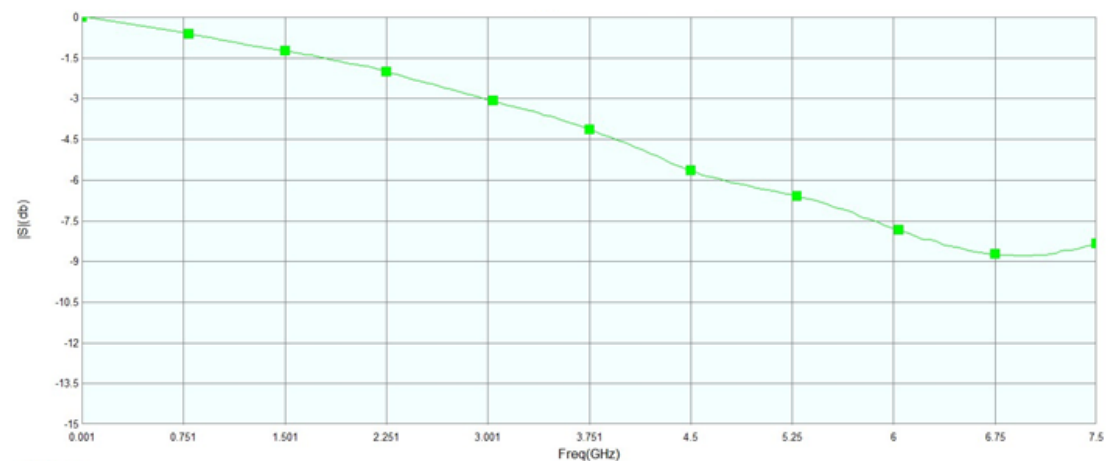


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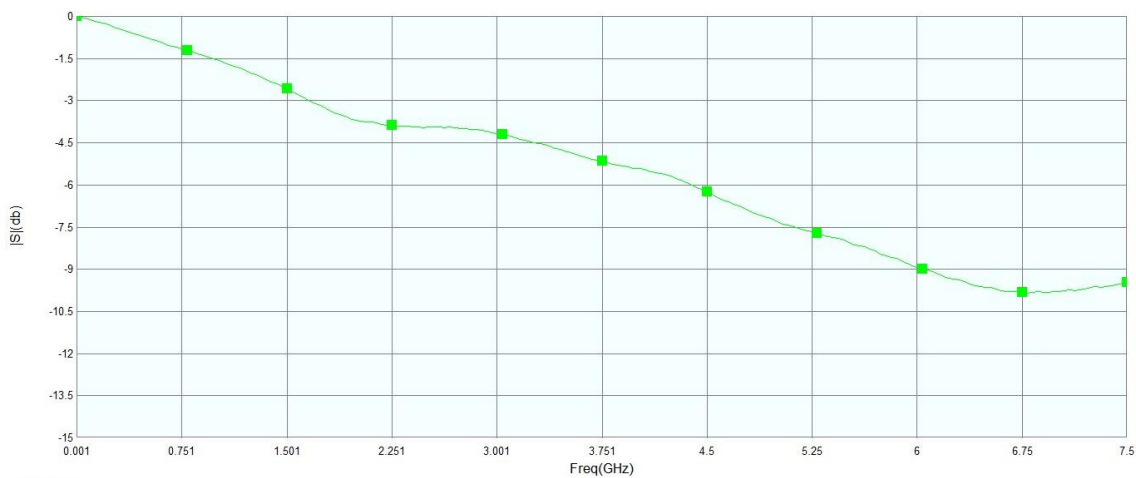
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W4F301-RC-10

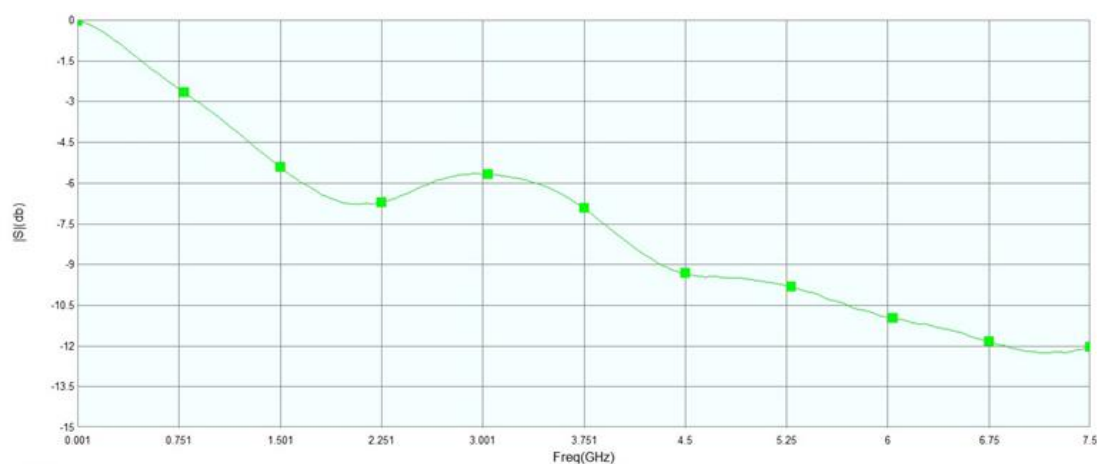


W4F361-RC-10

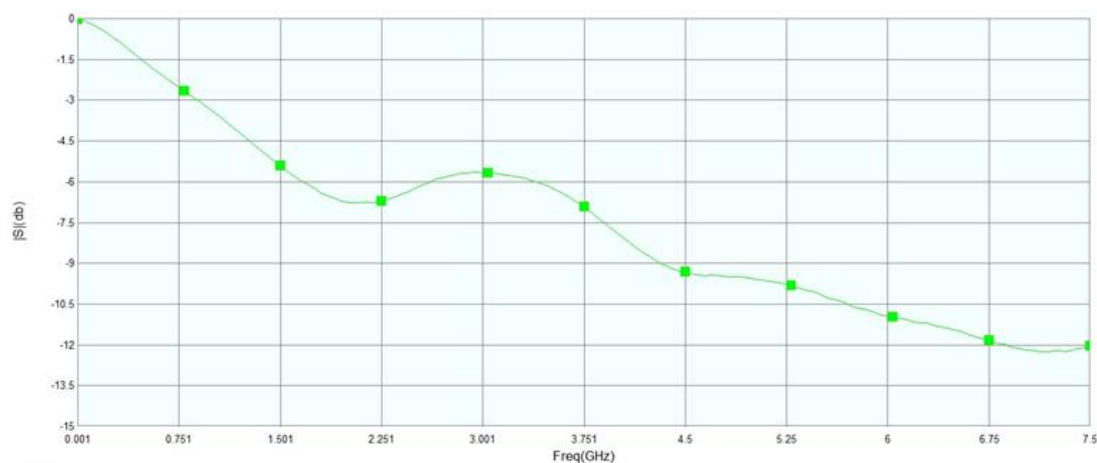


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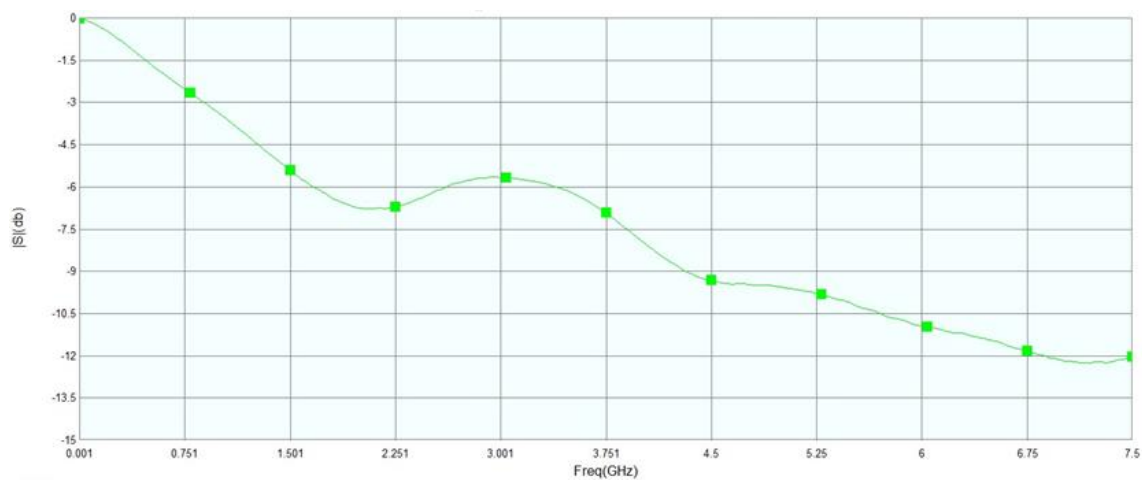
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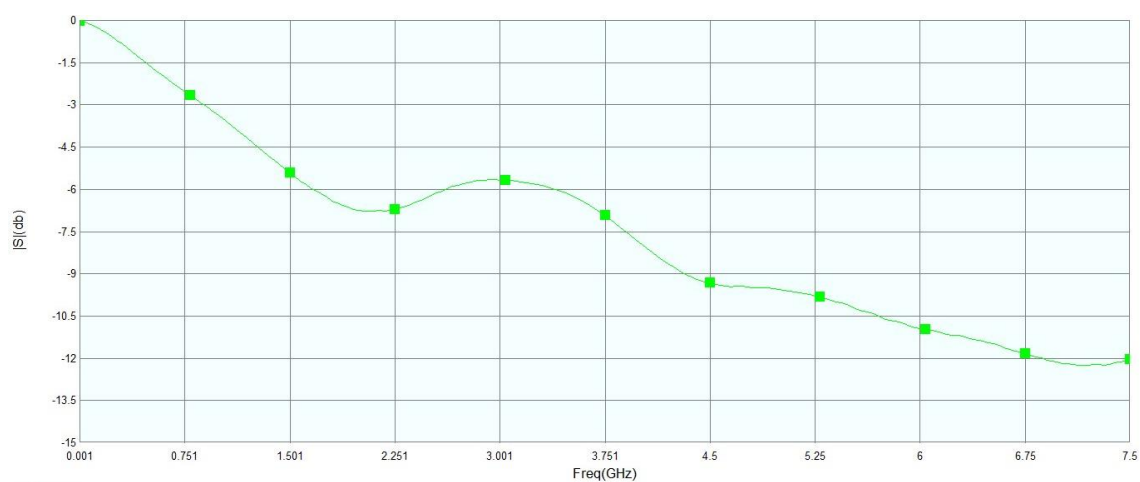


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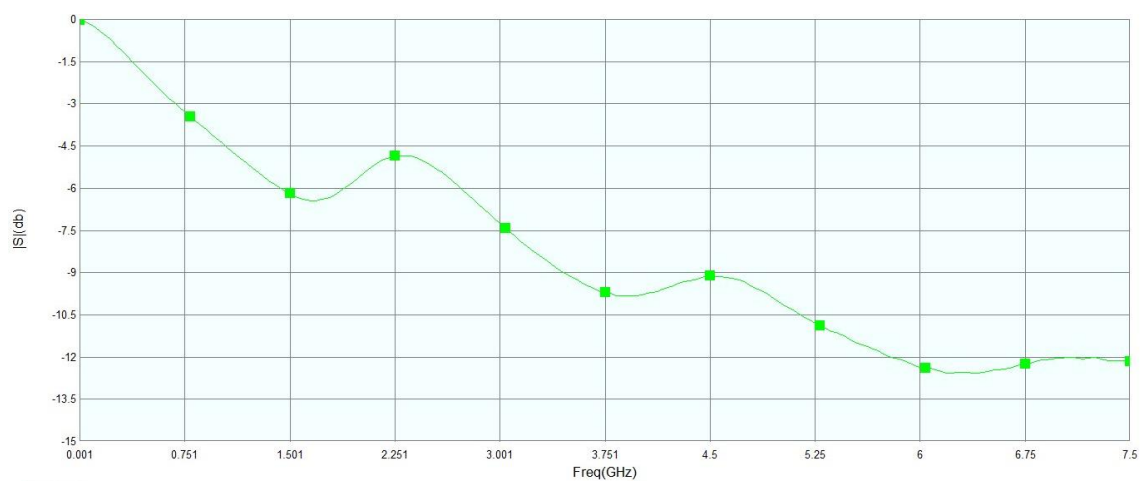


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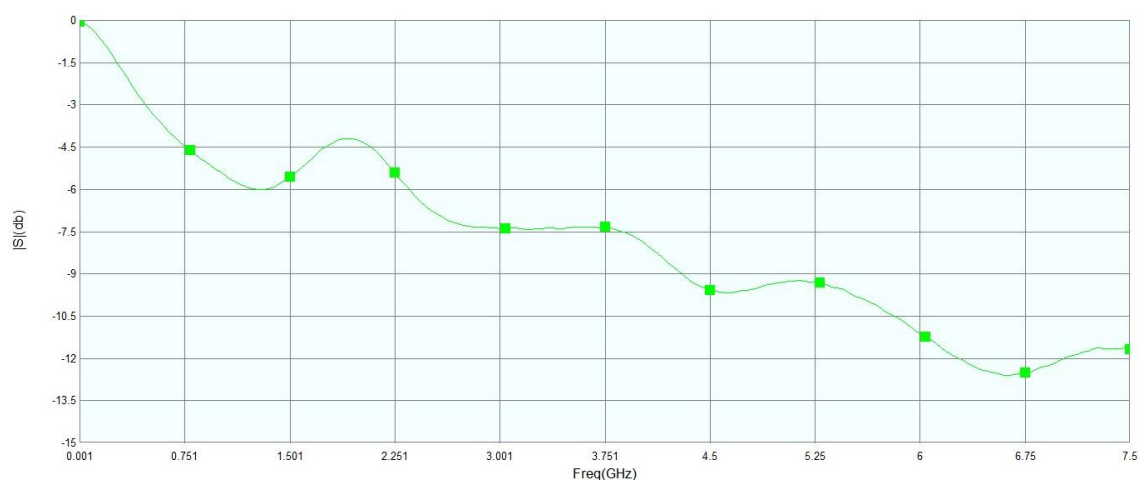
W4F601-RC-10



W4F102-RB-10



W4F222-RB-10



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8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

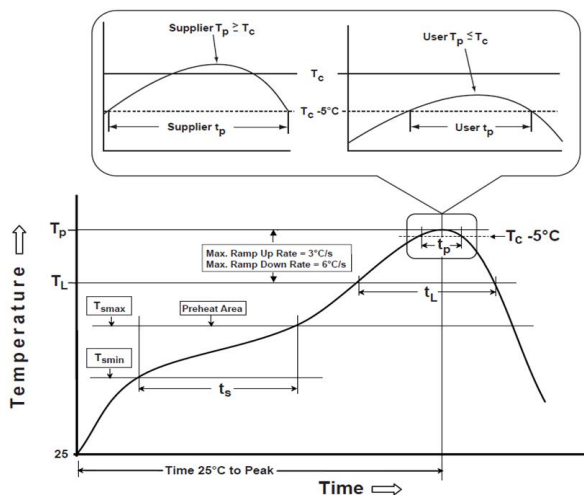
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

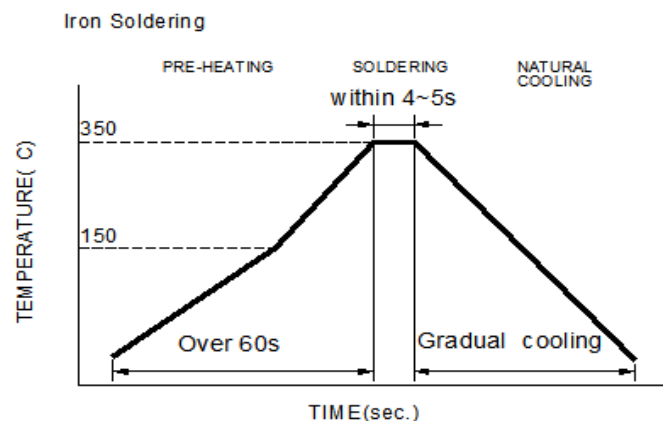
Note:

- Preheat circuit and products to 150°C.
- 355°C tip temperature (Max.)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (Max.)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Iron Soldering times: 1 times max.

Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles

NOTE: Specifications subject to change without notice. Please check our website for latest information.

Table (1.1) Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min (T_{smin})	150°C
-Temperature Max (T_{smax})	200°C
-Time (t_s) from (T_{smin} to T_{smax})	60-120seconds
Ramp-up rate (T_L to T_p)	3°C /second max.
Liquids temperature (T_L)	217°C
Time (t_L) maintained above T_L	60-150 seconds
Classification temperature (T_c)	See Table (1.2)
Time (t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	* < 30 seconds
Ramp-down rate (T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p : maximum peak package body temperature, **T_c** : the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c** .

*Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

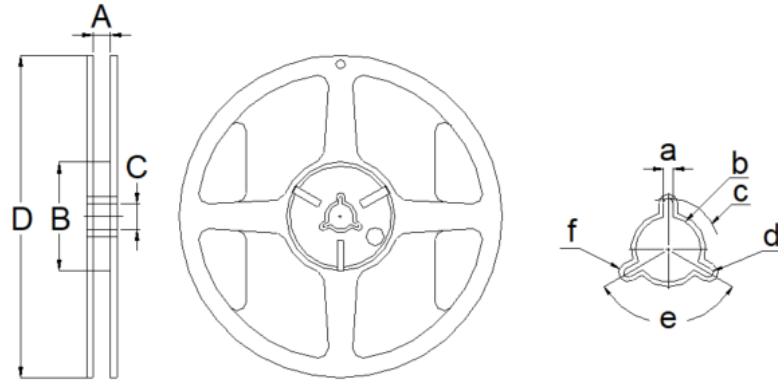
	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E.

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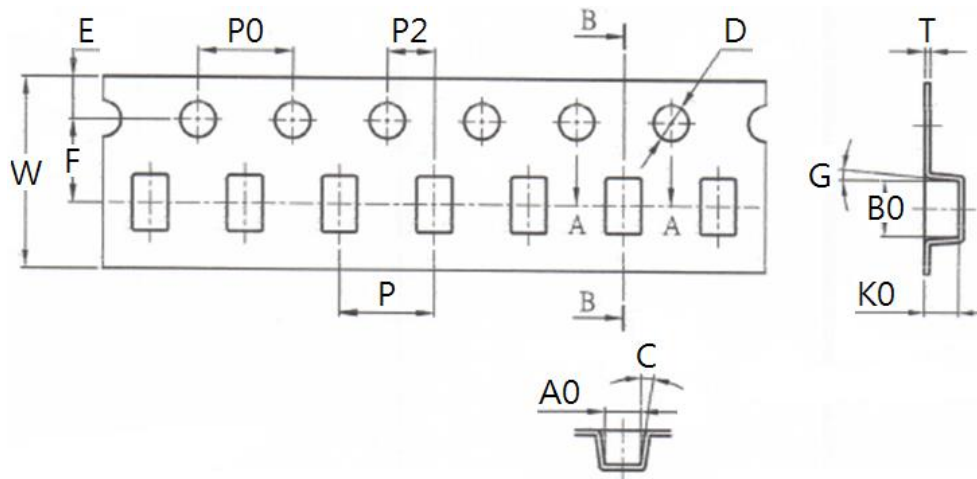
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



Type	A	B	C	D	a
	9.0±0.5	60.0±2.0	13.5 Ref	178.0±2.0	2.0 Ref
7"x8mm	b	c	d	e	f
	13.5 Ref	R10.5	R0.5	120°	R1.9

9-2. Tape Dimension (Unit: mm)

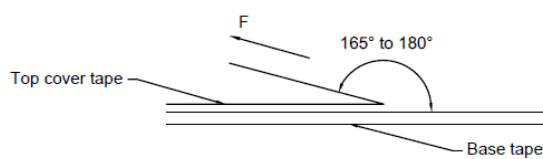


W	P	E	F	P2	D	D1
8.00±0.10	4.00±0.10	1.75±0.10	3.50±0.05	2.00±0.05	1.50+0.10/-0.00	1.00±0.10
P0	A0	B0	K0	T	C	G
4.00±0.10	1.88±0.10	3.50±0.10	2.20±0.10	0.26±0.05	8°	5°

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9-3. Packaging Quantity (Unit: Pcs)

Chip/ Reel	2,000
Inner Box	10,000
Middle Box	50,000
Carton	100,000

9-4. Tearing Off Force

The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300±10

Tape Size	8 mm	12 to 56 mm	72 mm or Wider
Tearing Off Force (grams)	10~100	10~130	10~150

Application Notice**1. Storage Conditions**

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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